



COPY OF PAPERS
ORIGINALLY FILED

2833

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

)
Yeo et al.

)
Serial No.: 10/078,719

)
Filed: February 19, 2002

)
For: **ENHANCED CHIP SCALE PACKAGE
FOR FLIP CHIPS**

)
Attorney's Docket No. 4795-001

)
Examiner
Group Art Unit 2833

TECHNOLOGY CENTER 2800

RECEIVED

MAY - 9 2002

Raleigh, North Carolina

May 1, 2002

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

The above-identified application claims priority based on Singapore Application No.

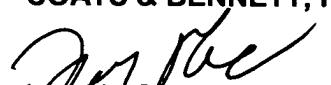
200106785-9. Enclosed please find a certified copy of Singapore Application No. 200106785-9.

We filed the above-identified U.S. application without the certified copy.

Respectfully submitted,

COATS & BENNETT, P.L.L.C.

By:


Larry L. Coats
Registration No. 25,620

P.O. Box 5
Raleigh, NC 27602
Telephone: (919) 854-1844

CERTIFICATE OF MAILING

I HEREBY CERTIFY THAT THIS DOCUMENT IS BEING DEPOSITED WITH THE UNITED STATE POSTAL SERVICE AS FIRST CLASS MAIL, POSTAGE PREPAID, IN AN ENVELOPE ADDRESSED TO: **COMMISSIONER FOR PATENTS, WASHINGTON, D.C. 20231**

Signature: 

Date: 5/1/02

ARTIFACT SHEET

Indicate quantity of item(s) received by the USPTO but not scanned.

Priority Document No. 200106785-9 Country Singapore.
Doc Code: TRPR

CD(s) containing computer program listing
Doc Code: Computer

Stapled Set(s) of Extra Color Drawings
Doc Code: Artifact

CD(s) containing pages of specification and/or sequence listing
Doc Code: Artifact

CD(s) with content unspecified
Doc Code: Artifact

Microfilm(s)
Doc Code: Artifact

Video tape(s)
Doc Code: Artifact

Other mass storage media, description _____
Doc Code: Artifact

Model(s)
Doc Code: Artifact

Other, description _____
Doc Code: Artifact

Other, description _____
Doc Code: Artifact

Other, description _____
Doc Code: Artifact